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## Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	624
Number of Logic Elements/Cells	4992
Total RAM Bits	49152
Number of I/O	333
Number of Gates	257000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	484-BBGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep1k100fc484-3

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

- Software design support and automatic place-and-route provided by Altera development systems for Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations
- Flexible package options are available in 100 to 484 pins, including the innovative FineLine BGA<sup>TM</sup> packages (see Tables 2 and 3)
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), DesignWare components, Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, VeriBest, and Viewlogic

Table 2. ACEX	1K Package Option	ns & I/O Pin Count	Notes (1), (2)		
Device	100-Pin TQFP	144-Pin TQFP	208-Pin PQFP	256-Pin FineLine BGA	484-Pin FineLine BGA
EP1K10	66	92	120	136	136 (3)
EP1K30		102	147	171	171 (3)
EP1K50		102	147	186	249
EP1K100			147	186	333

#### Notes:

- ACEX 1K device package types include thin quad flat pack (TQFP), plastic quad flat pack (PQFP), and FineLine BGA packages.
- (2) Devices in the same package are pin-compatible, although some devices have more I/O pins than others. When planning device migration, use the I/O pins that are common to all devices.
- (3) This option is supported with a 256-pin FineLine BGA package. By using SameFrame<sup>TM</sup> pin migration, all FineLine BGA packages are pin-compatible. For example, a board can be designed to support 256-pin and 484-pin FineLine BGA packages.

Table 3. ACEX 1K F	Package Sizes				
Device	100-Pin TQFP	144-Pin TQFP	208-Pin PQFP	256-Pin FineLine BGA	484-Pin FineLine BGA
Pitch (mm)	0.50	0.50	0.50	1.0	1.0
Area (mm²)	256	484	936	289	529
$\begin{array}{c} \text{Length} \times \text{width} \\ \text{(mm} \times \text{mm)} \end{array}$	16×16	22 × 22	30.6 × 30.6	17 × 17	23 × 23

The logic array consists of logic array blocks (LABs). Each LAB contains eight LEs and a local interconnect. An LE consists of a 4-input LUT, a programmable flipflop, and dedicated signal paths for carry and cascade functions. The eight LEs can be used to create medium-sized blocks of logic—such as 8-bit counters, address decoders, or state machines—or combined across LABs to create larger logic blocks. Each LAB represents about 96 usable logic gates.

Signal interconnections within ACEX 1K devices (as well as to and from device pins) are provided by the FastTrack Interconnect routing structure, which is a series of fast, continuous row and column channels that run the entire length and width of the device.

Each I/O pin is fed by an I/O element (IOE) located at the end of each row and column of the FastTrack Interconnect routing structure. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an output or input register to feed input, output, or bidirectional signals. When used with a dedicated clock pin, these registers provide exceptional performance. As inputs, they provide setup times as low as 1.1 ns and hold times of 0 ns. As outputs, these registers provide clock-to-output times as low as 2.5 ns. IOEs provide a variety of features, such as JTAG BST support, slew-rate control, tri-state buffers, and open-drain outputs.

Figure 1 shows a block diagram of the ACEX 1K device architecture. Each group of LEs is combined into an LAB; groups of LABs are arranged into rows and columns. Each row also contains a single EAB. The LABs and EABs are interconnected by the FastTrack Interconnect routing structure. IOEs are located at the end of each row and column of the FastTrack Interconnect routing structure.

## **Embedded Array Block**

The EAB is a flexible block of RAM, with registers on the input and output ports, that is used to implement common gate array megafunctions. Because it is large and flexible, the EAB is suitable for functions such as multipliers, vector scalars, and error correction circuits. These functions can be combined in applications such as digital filters and microcontrollers.

Logic functions are implemented by programming the EAB with a read-only pattern during configuration, thereby creating a large LUT. With LUTs, combinatorial functions are implemented by looking up the results rather than by computing them. This implementation of combinatorial functions can be faster than using algorithms implemented in general logic, a performance advantage that is further enhanced by the fast access times of EABs. The large capacity of EABs enables designers to implement complex functions in a single logic level without the routing delays associated with linked LEs or field-programmable gate array (FPGA) RAM blocks. For example, a single EAB can implement any function with 8 inputs and 16 outputs. Parameterized functions, such as LPM functions, can take advantage of the EAB automatically.

The ACEX 1K enhanced EAB supports dual-port RAM. The dual-port structure is ideal for FIFO buffers with one or two clocks. The ACEX 1K EAB can also support up to 16-bit-wide RAM blocks. The ACEX 1K EAB can act in dual-port or single-port mode. When in dual-port mode, separate clocks may be used for EAB read and write sections, allowing the EAB to be written and read at different rates. It also has separate synchronous clock enable signals for the EAB read and write sections, which allow independent control of these sections.

The EAB can also be used for bidirectional, dual-port memory applications where two ports read or write simultaneously. To implement this type of dual-port memory, two EABs are used to support two simultaneous reads or writes.

Alternatively, one clock and clock enable can be used to control the input registers of the EAB, while a different clock and clock enable control the output registers (see Figure 2).

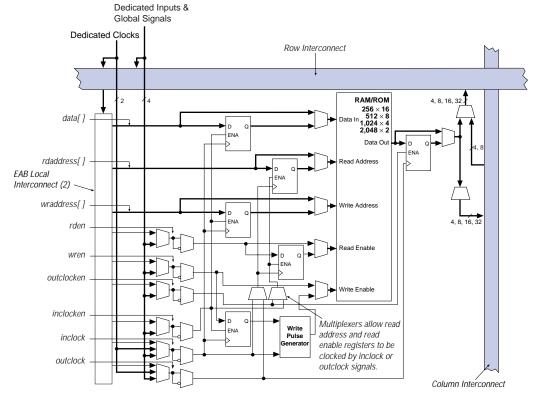


Figure 2. ACEX 1K Device in Dual-Port RAM Mode Note (1)

#### Notes:

- (1) All registers can be asynchronously cleared by EAB local interconnect signals, global signals, or the chip-wide reset.
- (2) EP1K10, EP1K30, and EP1K50 devices have 88 EAB local interconnect channels; EP1K100 devices have 104 EAB local interconnect channels.

The EAB can use Altera megafunctions to implement dual-port RAM applications where both ports can read or write, as shown in Figure 3. The ACEX 1K EAB can also be used in a single-port mode (see Figure 4).

If necessary, all EABs in a device can be cascaded to form a single RAM block. EABs can be cascaded to form RAM blocks of up to 2,048 words without impacting timing. Altera software automatically combines EABs to meet a designer's RAM specifications.

EABs provide flexible options for driving and controlling clock signals. Different clocks and clock enables can be used for reading and writing to the EAB. Registers can be independently inserted on the data input, EAB output, write address, write enable signals, read address, and read enable signals. The global signals and the EAB local interconnect can drive write-enable, read-enable, and clock-enable signals. The global signals, dedicated clock pins, and EAB local interconnect can drive the EAB clock signals. Because the LEs drive the EAB local interconnect, the LEs can control write-enable, read-enable, clear, clock, and clock-enable signals.

An EAB is fed by a row interconnect and can drive out to row and column interconnects. Each EAB output can drive up to two row channels and up to two column channels; the unused row channel can be driven by other LEs. This feature increases the routing resources available for EAB outputs (see Figures 2 and 4). The column interconnect, which is adjacent to the EAB, has twice as many channels as other columns in the device.

## Logic Array Block

An LAB consists of eight LEs, their associated carry and cascade chains, LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure to the ACEX 1K architecture, facilitating efficient routing with optimum device utilization and high performance. Figure 7 shows the ACEX 1K LAB.

#### **Clearable Counter Mode**

The clearable counter mode is similar to the up/down counter mode, but it supports a synchronous clear instead of the up/down control. The clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used; one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer. The output of this multiplexer is AND ed with a synchronous clear signal.

#### Internal Tri-State Emulation

Internal tri-state emulation provides internal tri-states without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable (OE) signals select which signal drives the bus. However, if multiple OE signals are active, contending signals can be driven onto the bus. Conversely, if no OE signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The Altera software automatically implements tri-state bus functionality with a multiplexer.

#### Clear & Preset Logic Control

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE asynchronously loads signals into a register. Either LABCTRL1 or LABCTRL2 can control the asynchronous clear. Alternatively, the register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

During compilation, the compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six modes chosen during design entry:

- Asynchronous clear
- Asynchronous preset
- Asynchronous clear and preset
- Asynchronous load with clear
- Asynchronous load with preset
- Asynchronous load without clear or preset

#### **Asynchronous Clear**

The flipflop can be cleared by either LABCTRL1 or LABCTRL2. In this mode, the preset signal is tied to VCC to deactivate it.

#### **Asynchronous Preset**

An asynchronous preset is implemented as an asynchronous load, or with an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a one into the register. Alternatively, the Altera software can provide preset control by using the clear and inverting the register's input and output. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

#### **Asynchronous Preset & Clear**

When implementing asynchronous clear and preset, LABCTRL1 controls the preset, and LABCTRL2 controls the clear. DATA3 is tied to VCC, so that asserting LABCTRL1 asynchronously loads a one into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

#### **Asynchronous Load with Clear**

When implementing an asynchronous load in conjunction with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear; LABCTRL2 does not have to feed the preset circuits.

#### **Asynchronous Load with Preset**

When implementing an asynchronous load in conjunction with preset, the Altera software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 presets the register, while asserting LABCTRL1 loads the register. The Altera software inverts the signal that drives DATA3 to account for the inversion of the register's output.

#### Asynchronous Load without Preset or Clear

When implementing an asynchronous load without preset or clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

On all ACEX 1K devices, the input path from the I/O pad to the FastTrack Interconnect has a programmable delay element that can be used to guarantee a zero hold time. Depending on the placement of the IOE relative to what it is driving, the designer may choose to turn on the programmable delay to ensure a zero hold time or turn it off to minimize setup time. This feature is used to reduce setup time for complex pin-to-register paths (e.g., PCI designs).

Each IOE selects the clock, clear, clock enable, and output enable controls from a network of I/O control signals called the peripheral control bus. The peripheral control bus uses high-speed drivers to minimize signal skew across devices and provides up to 12 peripheral control signals that can be allocated as follows:

- Up to eight output enable signals
- Up to six clock enable signals
- Up to two clock signals
- Up to two clear signals

If more than six clock-enable or eight output-enable signals are required, each IOE on the device can be controlled by clock enable and output enable signals driven by specific LEs. In addition to the two clock signals available on the peripheral control bus, each IOE can use one of two dedicated clock pins. Each peripheral control signal can be driven by any of the dedicated input pins or the first LE of each LAB in a particular row. In addition, a LE in a different row can drive a column interconnect, which causes a row interconnect to drive the peripheral control signal. The chipwide reset signal resets all IOE registers, overriding any other control signals.

When a dedicated clock pin drives IOE registers, it can be inverted for all IOEs in the device. All IOEs must use the same sense of the clock. For example, if any IOE uses the inverted clock, all IOEs must use the inverted clock, and no IOE can use the non-inverted clock. However, LEs can still use the true or complement of the clock on an LAB-by-LAB basis.

The incoming signal may be inverted at the dedicated clock pin and will drive all IOEs. For the true and complement of a clock to be used to drive IOEs, drive it into both global clock pins. One global clock pin will supply the true, and the other will supply the complement.

When the true and complement of a dedicated input drives IOE clocks, two signals on the peripheral control bus are consumed, one for each sense of the clock.

#### Column-to-IOE Connections

When an IOE is used as an input, it can drive up to two separate column channels. When an IOE is used as an output, the signal is driven by a multiplexer that selects a signal from the column channels. Two IOEs connect to each side of the column channels. Each IOE can be driven by column channels via a multiplexer. The set of column channels is different for each IOE (see Figure 17).

Each IOE is driven by a m-to-1 multiplexer

Column Interconnect

Figure 17. ACEX 1K Column-to-IOE Connections Note (1)

## Note:

The values for m and n are shown in Table 9.

Table 9 lists the ACEX 1K column-to-IOE interconnect resources.

Each IOE can drive two column channels.

Table 9. ACEX 1K	Table 9. ACEX 1K Column-to-IOE Interconnect Resources								
Device	Channels per Column (n)	Column Channels per Pin (m)							
EP1K10	24	16							
EP1K30	24	16							
EP1K50	24	16							
EP1K100	24	16							

## PCI Pull-Up Clamping Diode Option

ACEX 1K devices have a pull-up clamping diode on every I/O, dedicated input, and dedicated clock pin. PCI clamping diodes clamp the signal to the  $V_{\rm CCIO}$  value and are required for 3.3-V PCI compliance. Clamping diodes can also be used to limit overshoot in other systems.

Clamping diodes are controlled on a pin-by-pin basis. When  $V_{\rm CCIO}$  is 3.3 V, a pin that has the clamping diode option turned on can be driven by a 2.5-V or 3.3-V signal, but not a 5.0-V signal. When  $V_{\rm CCIO}$  is 2.5 V, a pin that has the clamping diode option turned on can be driven by a 2.5-V signal, but not a 3.3-V or 5.0-V signal. Additionally, a clamping diode can be activated for a subset of pins, which allows a device to bridge between a 3.3-V PCI bus and a 5.0-V device.

#### Slew-Rate Control

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slower slew rate reduces system noise and adds a maximum delay of 4.3 ns. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate pin-by-pin or assign a default slew rate to all pins on a device-wide basis. The slow slew rate setting affects only the falling edge of the output.

## **Open-Drain Output Option**

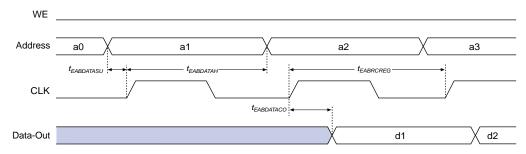
ACEX 1K devices provide an optional open-drain output (electrically equivalent to open-collector output) for each I/O pin. This open-drain output enables the device to provide system-level control signals (e.g., interrupt and write enable signals) that can be asserted by any of several devices. It can also provide an additional wired- $\[OR]$  plane.

#### MultiVolt I/O Interface

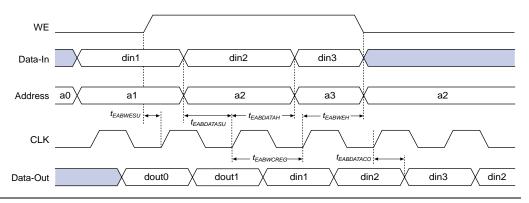
The ACEX 1K device architecture supports the MultiVolt I/O interface feature, which allows ACEX 1K devices in all packages to interface with systems of differing supply voltages. These devices have one set of  $V_{CC}$  pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

Figure 30. EAB Synchronous Timing Waveforms

#### **EAB Synchronous Read**



#### EAB Synchronous Write (EAB Output Registers Used)



Tables 22 through 26 describe the ACEX 1K device internal timing parameters.

Table 22. LE	Timing Microparameters (Part 1 of 2) Note (1)	
Symbol	Parameter	Conditions
$t_{LUT}$	LUT delay for data-in	
t <sub>CLUT</sub>	LUT delay for carry-in	
t <sub>RLUT</sub>	LUT delay for LE register feedback	
t <sub>PACKED</sub>	Data-in to packed register delay	
t <sub>EN</sub>	LE register enable delay	
t <sub>CICO</sub>	Carry-in to carry-out delay	
t <sub>CGEN</sub>	Data-in to carry-out delay	
t <sub>CGENR</sub>	LE register feedback to carry-out delay	

Symbol	Parameter	Conditions	
t <sub>DIN2IOE</sub>	Delay from dedicated input pin to IOE control input	(7)	
t <sub>DIN2LE</sub>	Delay from dedicated input pin to LE or EAB control input	(7)	
t <sub>DIN2DATA</sub>	Delay from dedicated input or clock to LE or EAB data	(7)	
t <sub>DCLK2IOE</sub>	Delay from dedicated clock pin to IOE clock	(7)	
t <sub>DCLK2LE</sub>	Delay from dedicated clock pin to LE or EAB clock	(7)	
t <sub>SAMELAB</sub>	Routing delay for an LE driving another LE in the same LAB	(7)	
t <sub>SAMEROW</sub>	Routing delay for a row IOE, LE, or EAB driving a row IOE, LE, or EAB in the same row	(7)	
t <sub>SAME</sub> COLUMN	Routing delay for an LE driving an IOE in the same column	(7)	
t <sub>DIFFROW</sub>	Routing delay for a column IOE, LE, or EAB driving an LE or EAB in a different row	(7)	
t <sub>TWOROWS</sub>	Routing delay for a row IOE or EAB driving an LE or EAB in a different row	(7)	
t <sub>LEPERIPH</sub>	Routing delay for an LE driving a control signal of an IOE via the peripheral control bus	(7)	
t <sub>LABCARRY</sub>	Routing delay for the carry-out signal of an LE driving the carry-in signal of a different LE in a different LAB		
t <sub>LABCASC</sub>	Routing delay for the cascade-out signal of an LE driving the cascade-in signal of a different LE in a different LAB		

#### Notes to tables:

- Microparameters are timing delays contributed by individual architectural elements. These parameters cannot be measured explicitly.
- Operating conditions:  $V_{CCIO} = 3.3 \text{ V} \pm 10\%$  for commercial or industrial and extended use in ACEX 1K devices
- Operating conditions:  $V_{CCIO} = 2.5 \text{ V} \pm 5\%$  for commercial or industrial and extended use in ACEX 1K devices. Operating conditions:  $V_{CCIO} = 2.5 \text{ V} \text{ or } 3.3 \text{ V}$ . (3)
- (4)
- Because the RAM in the EAB is self-timed, this parameter can be ignored when the WE signal is registered.
- EAB macroparameters are internal parameters that can simplify predicting the behavior of an EAB at its boundary; these parameters are calculated by summing selected microparameters.
- These parameters are worst-case values for typical applications. Post-compilation timing simulation and timing analysis are required to determine actual worst-case performance.

Symbol			Speed	Grade			Unit
	_	1	-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		1.8		2.4		2.9	ns
t <sub>DIN2LE</sub>		1.5		1.8		2.4	ns
t <sub>DIN2DATA</sub>		1.5		1.8		2.2	ns
t <sub>DCLK2IOE</sub>		2.2		2.6		3.0	ns
t <sub>DCLK2LE</sub>		1.5		1.8		2.4	ns
t <sub>SAMELAB</sub>		0.1		0.2		0.3	ns
t <sub>SAMEROW</sub>		2.0		2.4		2.7	ns
t <sub>SAMECOLUMN</sub>		0.7		1.0		0.8	ns
DIFFROW		2.7		3.4		3.5	ns
t <sub>TWOROWS</sub>		4.7		5.8		6.2	ns
LEPERIPH		2.7		3.4		3.8	ns
LABCARRY		0.3		0.4		0.5	ns
t <sub>LABCASC</sub>		0.8		0.8		1.1	ns

Table 42. EP1K3	0 External Ti	ming Param	<b>eters</b> Not	es (1), (2)					
Symbol		Speed Grade							
		-1		-2		3			
	Min	Max	Min	Max	Min	Max			
t <sub>DRR</sub>		8.0		9.5		12.5	ns		
t <sub>INSU</sub> (3)	2.1		2.5		3.9		ns		
t <sub>INH</sub> (3)	0.0		0.0		0.0		ns		
t <sub>оитсо</sub> (3)	2.0	4.9	2.0	5.9	2.0	7.6	ns		
t <sub>INSU</sub> (4)	1.1		1.5		-		ns		
t <sub>INH</sub> (4)	0.0		0.0		-		ns		
t <sub>оитсо</sub> (4)	0.5	3.9	0.5	4.9	-	-	ns		
t <sub>PCISU</sub>	3.0		4.2		-		ns		
t <sub>PCIH</sub>	0.0		0.0		-		ns		
t <sub>PCICO</sub>	2.0	6.0	2.0	7.5	-	_	ns		

Symbol		Speed Grade							
	_	1	-2		-3				
	Min	Max	Min	Max	Min	Max			
t <sub>EABAA</sub>		3.7		5.2		7.0	ns		
t <sub>EABRCCOMB</sub>	3.7		5.2		7.0		ns		
t <sub>EABRCREG</sub>	3.5		4.9		6.6		ns		
t <sub>EABWP</sub>	2.0		2.8		3.8		ns		
t <sub>EABWCCOMB</sub>	4.5		6.3		8.6		ns		
t <sub>EABWCREG</sub>	5.6		7.8		10.6		ns		
t <sub>EABDD</sub>		3.8		5.3		7.2	ns		
t <sub>EABDATA</sub> CO		0.8		1.1		1.5	ns		
t <sub>EABDATASU</sub>	1.1		1.6		2.1		ns		
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns		
t <sub>EABWESU</sub>	0.7		1.0		1.3		ns		
t <sub>EABWEH</sub>	0.4		0.6		0.8		ns		
t <sub>EABWDSU</sub>	1.2		1.7		2.2		ns		
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns		
t <sub>EABWASU</sub>	1.6		2.3		3.0		ns		
t <sub>EABWAH</sub>	0.9		1.2		1.8		ns		
t <sub>EABWO</sub>		3.1		4.3		5.9	ns		

Symbol			Speed	Grade			Unit
	_	1	-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		3.1		3.7		4.6	ns
t <sub>DIN2LE</sub>		1.7		2.1		2.7	ns
t <sub>DIN2DATA</sub>		2.7		3.1		5.1	ns
t <sub>DCLK2IOE</sub>		1.6		1.9		2.6	ns
t <sub>DCLK2LE</sub>		1.7		2.1		2.7	ns
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns
t <sub>SAMEROW</sub>		1.5		1.7		2.4	ns
t <sub>SAME</sub> COLUMN		1.0		1.3		2.1	ns
t <sub>DIFFROW</sub>		2.5		3.0		4.5	ns
t <sub>TWOROWS</sub>		4.0		4.7		6.9	ns
t <sub>LEPERIPH</sub>		2.6		2.9		3.4	ns
t <sub>LABCARRY</sub>		0.1		0.2		0.2	ns
t <sub>LABCASC</sub>		0.8		1.0		1.3	ns

Table 49. EP1K50	External Tin	ming Paramo	eters No	te (1)			
Symbol		Unit					
	-1		-2		-3		
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		8.0		9.5		12.5	ns
t <sub>INSU</sub> (2)	2.4		2.9		3.9		ns
t <sub>INH</sub> (2)	0.0		0.0		0.0		ns
t <sub>оитсо</sub> (2)	2.0	4.3	2.0	5.2	2.0	7.3	ns
t <sub>INSU</sub> (3)	2.4		2.9		-		ns
t <sub>INH</sub> (3)	0.0		0.0		-		ns
t <sub>оитсо</sub> (3)	0.5	3.3	0.5	4.1	-	-	ns
t <sub>PCISU</sub>	2.4		2.9		-		ns
t <sub>PCIH</sub>	0.0		0.0		-		ns
t <sub>PCICO</sub>	2.0	6.0	2.0	7.7	-	-	ns

Symbol			Speed	Grade			Unit
	_	1	-2		-	3	
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		1.7		2.0		2.6	ns
t <sub>IOC</sub>		0.0		0.0		0.0	ns
t <sub>IOCO</sub>		1.4		1.6		2.1	ns
t <sub>IOCOMB</sub>		0.5		0.7		0.9	ns
t <sub>IOSU</sub>	0.8		1.0		1.3		ns
t <sub>IOH</sub>	0.7		0.9		1.2		ns
t <sub>IOCLR</sub>		0.5		0.7		0.9	ns
t <sub>OD1</sub>		3.0		4.2		5.6	ns
t <sub>OD2</sub>		3.0		4.2		5.6	ns
t <sub>OD3</sub>		4.0		5.5		7.3	ns
$t_{XZ}$		3.5		4.6		6.1	ns
$t_{ZX1}$		3.5		4.6		6.1	ns
$t_{ZX2}$		3.5		4.6		6.1	ns
$t_{ZX3}$		4.5		5.9		7.8	ns
t <sub>INREG</sub>		2.0		2.6		3.5	ns
t <sub>IOFD</sub>		0.5		0.8		1.2	ns
t <sub>INCOMB</sub>		0.5		0.8		1.2	ns

Symbol	Speed Grade								
	-1		-2		-3				
	Min	Max	Min	Max	Min	Max			
t <sub>EABDATA1</sub>		1.5		2.0		2.6	ns		
t <sub>EABDATA1</sub>		0.0		0.0		0.0	ns		
t <sub>EABWE1</sub>		1.5		2.0		2.6	ns		
t <sub>EABWE2</sub>		0.3		0.4		0.5	ns		
t <sub>EABRE1</sub>		0.3		0.4		0.5	ns		
t <sub>EABRE2</sub>		0.0		0.0		0.0	ns		
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns		
t <sub>EABCO</sub>		0.3		0.4		0.5	ns		
t <sub>EABBYPASS</sub>		0.1		0.1		0.2	ns		
t <sub>EABSU</sub>	0.8		1.0		1.4		ns		
t <sub>EABH</sub>	0.1		0.1		0.2		ns		
t <sub>EABCLR</sub>	0.3		0.4		0.5		ns		
$t_{AA}$		4.0		5.1		6.6	ns		
$t_{WP}$	2.7		3.5		4.7		ns		
t <sub>RP</sub>	1.0		1.3		1.7		ns		
t <sub>WDSU</sub>	1.0		1.3		1.7		ns		
$t_{WDH}$	0.2		0.2		0.3		ns		
t <sub>WASU</sub>	1.6		2.1		2.8		ns		
t <sub>WAH</sub>	1.6		2.1		2.8		ns		
t <sub>RASU</sub>	3.0		3.9		5.2		ns		
t <sub>RAH</sub>	0.1		0.1		0.2		ns		
$t_{WO}$		1.5		2.0		2.6	ns		
$t_{DD}$		1.5		2.0		2.6	ns		
t <sub>EABOUT</sub>		0.2		0.3		0.3	ns		
t <sub>EABCH</sub>	1.5		2.0		2.5		ns		
t <sub>EABCL</sub>	2.7		3.5		4.7		ns		

Symbol	Speed Grade							
	-1		-2		-3			
	Min	Max	Min	Max	Min	Max		
t <sub>INSUBIDIR</sub> (3)	1.7		2.5		3.3		ns	
t <sub>INHBIDIR</sub> (3)	0.0		0.0		0.0		ns	
t <sub>INSUBIDIR</sub> (4)	2.0		2.8		-		ns	
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-		ns	
toutcobidir (3)	2.0	5.2	2.0	6.9	2.0	9.1	ns	
t <sub>XZBIDIR</sub> (3)		5.6		7.5		10.1	ns	
t <sub>ZXBIDIR</sub> (3)		5.6		7.5		10.1	ns	
toutcobidir (4)	0.5	3.0	0.5	4.6	-	-	ns	
t <sub>XZBIDIR</sub> (4)		4.6		6.5		-	ns	
t <sub>ZXBIDIR</sub> (4)		4.6		6.5		_	ns	

#### Notes to tables:

- (1) All timing parameters are described in Tables 22 through 29 in this data sheet.
- (2) These parameters are specified by characterization.
- (3) This parameter is measured without the use of the ClockLock or ClockBoost circuits.
- (4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

## Power Consumption

The supply power (P) for ACEX 1K devices can be calculated with the following equation:

$$P = P_{INT} + P_{IO} = (I_{CCSTANDBY} + I_{CCACTIVE}) \times V_{CC} + P_{IO}$$

The  $I_{CCACTIVE}$  value depends on the switching frequency and the application logic. This value is calculated based on the amount of current that each LE typically consumes. The  $P_{IO}$  value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in *Application Note 74 (Evaluating Power for Altera Devices)*.



Compared to the rest of the device, the embedded array consumes a negligible amount of power. Therefore, the embedded array can be ignored when calculating supply current.

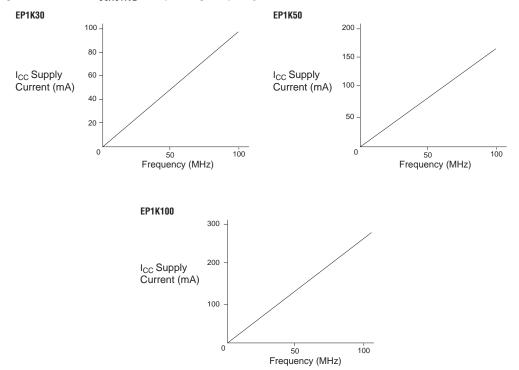


Figure 31. ACEX 1K I<sub>CCACTIVE</sub> vs. Operating Frequency

# Configuration & Operation

The ACEX 1K architecture supports several configuration schemes. This section summarizes the device operating modes and available device configuration schemes.

## **Operating Modes**

The ACEX 1K architecture uses SRAM configuration elements that require configuration data to be loaded every time the circuit powers up. The process of physically loading the SRAM data into the device is called *configuration*. Before configuration, as  $V_{\rm CC}$  rises, the device initiates a Power-On Reset (POR). This POR event clears the device and prepares it for configuration. The ACEX 1K POR time does not exceed 50  $\mu$ s.



When configuring with a configuration device, refer to the relevant configuration device data sheet for POR timing information.

## Revision History

The information contained in the *ACEX 1K Programmable Logic Device Family Data Sheet* version 3.4 supersedes information published in previous versions.

The following changes were made to the *ACEX 1K Programmable Logic Device Family Data Sheet* version 3.4: added extended temperature support.